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## \*BIBDATASHEET\*

Bib Data Sheet

CONFIRMATION NO. 9352

SERIAL NUMBER 10/682,273	FILING DATE 10/08/2003  RULE	CLASS 438	GROUP ART UNIT 2823	ATTORNEY DOCKET NO. 27-021
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## APPLICANTS

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Byung Hoon Ahn, Singapore, SINGAPORE; *WP*\*\* CONTINUING DATA \*\*\*\*\*  
*none WP*\*\* FOREIGN APPLICATIONS \*\*\*\*\*  
*none WP*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 01/03/2004

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY SINGAPORE	SHEETS DRAWING 5	TOTAL CLAIMS 26	INDEPENDENT CLAIMS 4
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged <i>[Signature]</i> Examiner's Signature	Initials			

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## TITLE

Method for fabricating semiconductor packages, and leadframe assemblies for the fabrication thereof

FILING FEE  RECEIVED 964	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit
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